



smith & hopen, p.a.

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December 19, 2001

Hon. Commissioner for Patents
Washington, D.C. 20231

Applicant: Guy Middleton
Serial No.: 09/683,042
Filing Date: 11/12/2001
For: Compression/Decompression Method
Our Reference No.: 1320.06

Examiner: Unassigned
Art Unit: 2176

Dear Sir:

Enclosed please find the following:

1. Information Disclosure Statement By Applicant- 2 pages;
2. Copies of four (4) Foreign Patent Documents;
3. Copies of two (2) Non-Patent Literature Documents; and
4. Self-addressed, postage prepaid post card to serve as a receipt for items 1-3.

Very respectfully,

SMITH & HOPEN

By: Ronald E. Smith
ron.smith@baypatents.com

RES/dp
enclosure

CERTIFICATE OF MAILING
(37 C.F.R. 1.8)

I HEREBY CERTIFY that this correspondence is being mailed with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Hon. Commissioner for Patents, Washington, D.C. 20231 on December 19, 2001.

Date: December 19, 2001

Deborah Preza